




**SPECIFICATION SHEET**

<b>SPECIFICATION SHEET NO.</b>	N0712- CA55B6R3K157TA
<b>DATE</b>	July 12, 2021
<b>REVISION</b>	A0
<b>DESCRIPTION</b>	<p>SMD Conductive Polymer Tantalum Capacitors</p> <p><a href="#">EIA code 3528-21</a></p> <p><a href="#">CA55 Series, Case B, L3.50*W2.80*H2.10mm</a></p> <p>Rated voltage 6.3Vdc, Capacitance 150μF, Tolerance ±10%, <a href="#">ESR 250 mΩ Max.</a></p> <p>Operating Temp. Range -55°C ~+125°C,</p> <p>Package in Tape/Reel, 2000pcs/Reel</p> <p>RoHS/RoHS III compliant</p>
<b>CUSTOMER</b>	
<b>CUSTOMER PART NUMBER</b>	
<b>CROSS REF. PART NUMBER</b>	
<b>ORIGINAL PART NUMBER</b>	CA55-B6R3K157T
<b>PART CODE</b>	CA55B6R3K157TA

<b>VENDOR APPROVE</b>			
Issued/Checked/Approved			
DATE: July 12, 2021			

<b>CUSTOMER APPROVE</b>	
DATE:	

**SMD CONDUCTIVE POLYMER TANT. CAP. CA55 SERIES CASE B**

**MAIN FEATURE**

- RoHS III Compliant
- Wide Operating Temperature Range -55~+125°C
- Small volume, High Stability
- Low ESR Value
- Good Frequency Characteristic

**APPLICATION**

- For Surface Mount Consumer Electronic Equipment
- Color TV sets, PC, Mobile Telephone sets Pickup camera Radar etc.

**RFQ**  
[Request For Quotation](#)

**PART CODE GUIDE**

CA55	B	6R3	K	157	T	A
1	2	3	4	5	6	7

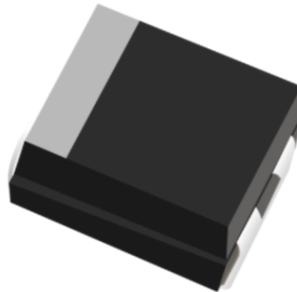
- 1) **CA55**: Series code for SMD Conductive Polymer Tantalum Capacitors
- 2) **B**: Case size code for Dimension [L3.50\\*W2.80\\*H2.100mm, EIA code 3528-21](#)
- 3) **6R3**: Rated voltage Code, 6R3: 6.3 Vdc
- 4) **K**: Capacitance Tolerance code, K: +/-10%; M: +/-20%
- 5) **157**: Capacitance Code: 1<sup>st</sup> two digits represent Significant figures, 3<sup>rd</sup> Digit specifies number of Zeros. 157: 150µF
- 6) **T**: Package in Tape/Reel, 2000pcs/Reel
- 7) **A**: Internal control or Customer’s Special Code (A~Z or 1~9)

**SMD CONDUCTIVE POLYMER TANT. CAP. CA55 SERIES CASE B**

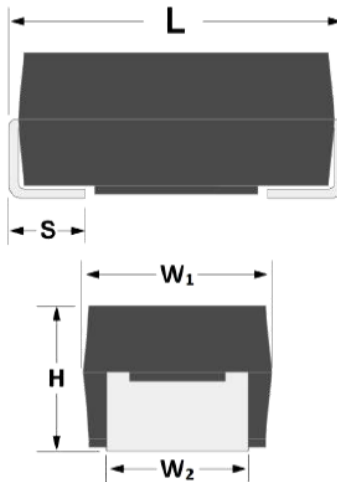
DIMENSION (Unit: mm)



Image for reference



CA55 Case B



Item	Dimension
L	3.50±0.20
W1	2.80±0.20
W2	2.20±0.20
H	2.10±0.20
S	0.70±0.20

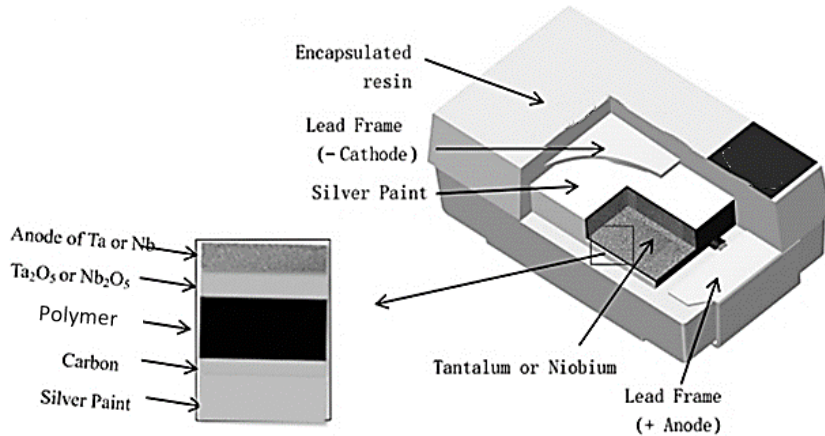
Marking: J157



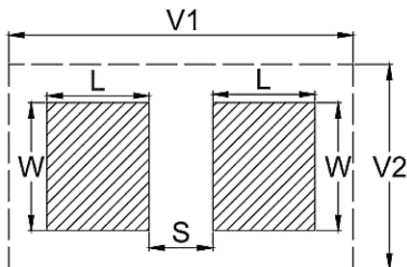
Code	F	G	J	A	C	D	E	V	T
Rate Voltage (V)	2.5	4	6.3	10	16	20	25	35	50

**SMD CONDUCTIVE POLYMER TANT. CAP. CA55 SERIES CASE B**

**PRODUCT STRUCTURE** Image for reference



**LAND DIMENSIONS/COURTYARD**



**Density Level A:** For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes.

**Density Level B:** For products with a moderate level of component density. Provides Recommended Profile Conditions for reflow solder processes.

**Density Level C:** For high component density product applications. Before adapting the Min. land pattern variations, the user should perform qualification testing based on the conditions outlined in IPC - 7351).

**Note:**

1. Height of these chips may create problems in wave soldering.
2. Land pattern geometry is too small for silkscreen outline.

Case Code	Item	Code	Dimension (mm)
B (EIA 3528-21)	Density Level A Max. (Most) Land Protrusion	W	2.35
		L	2.21
		S	0.92
		V1	6.32
		V2	4.00
	Density Level B Max. (Nominal) Land Protrusion	W	2.23
		L	1.80
		S	1.12
		V1	5.22
		V2	3.50
	Density Level C Max. (Least) Land Protrusion	W	2.13
		L	1.42
		S	1.28
		V1	4.36
		V2	3.24

**SMD CONDUCTIVE POLYMER TANT. CAP. CA55 SERIES CASE B**
**ELECTRONICAL CHARACTERISTICS**

Item	Unit	Symbol	Characteristic	Condition
Operating Temperature Range	°C		-55~+125	@ > 85°C Applying Voltage Derating: 10V
Rated Voltage Range	V DC		<b>6.3</b>	
Capacitance Tolerance	%		±10	@25°C, 100Hz
Leakage Current	µA	I <sub>0</sub>	Measured after 5 Minutes Application of rated voltage reading, I <sub>0</sub> ≤ 0.01 C <sub>R</sub> U <sub>R</sub> or <b>95µA Max.</b> whichever is greater @25 °C	C <sub>R</sub> : (µF) Nominal Capacitance U <sub>R</sub> : (V) Rated voltage
Capacitance	µF	C <sub>R</sub>	<b>150</b>	@25°C, 100Hz
Dissipation Factor	%	tgδ	8.0 Max.	
ESR	mΩ		250 Max. or <a href="#">Specify</a>	@25°C, 100KHz

**TEMPERATURE CHARACTERISTICS**

Item	Unit	Dissipation Factor (tgδ Max)			Capacitance change			Leakage Current (I Max.)	
Temperature Characteristics		@Nominal Capacitance 150µF							
	°C	-55	+85	+125	-55	+85	+125	+85	+125
	%	9	9	12					
	%				±10	±10	±12		
	µA							8*I <sub>0</sub>	10*I <sub>0</sub>
Load Life		≤150% of the specified value			Within ± 10% of the initial value			≤ 8 * of the specified value	
Failure Rate Level		Under the normal load of 1000 hours, the failure rate of the product is less than 100 ppm							

**SMD CONDUCTIVE POLYMER TANT. CAP. CA55 SERIES CASE B**

**APPLICATION NTOE**

**Storage Condition**

- 1) Environmental temperature: 10°C ~ +30°C
- 2) Relative humidity no more than 60%
- 3) Storing period: No more than one and half year since the date of stocking.

**Application Guide**

**1) Ripple current and voltage**

If the ripple current is applied to the capacitor, the Joule heat (power dissipated) will be generated in the capacitor, so it will affect the reliability of the capacitor.

**(1) Power Dissipated**

The actual power dissipated can be calculated using the following formula:  $P=I^2 \times ESR$ .....Formula 1

P: Power dissipated (W); I: Ripple current (A); ESR: Equivalent series resistance ( $\Omega$ )

Power Dissipation for Case B ( EIA Code 3528-21): 75mW Max. @+25°C

**(2) Ripple current**

Using the maximum power dissipation 65mW Max., the ripple current can be calculated using the following

formula:  $I= \sqrt{\frac{P}{ESR}} \times K \times F$ .....Formula 2

K: Temperature derating factor..... Table 1; F: Frequency derating factor..... Table 2

ESR: Refer to the ratings of each specific product

Table 1: Temperature Drop Factor K

Temperature	Temperature Derating Factor K
25 °C	1
85 °C	0.9
125 °C	0.4

Table 2: Frequency Derating Factor F

Frequency (KHz)	10	100	500	1000
MnO2	0.80	1.0	1.15	1.20
Polymer	0.75	1.0	1.10	1.30

Using formula 3 to calculate corrugated voltage E:  $E=Z \times I$ ..... Formula 3

E: Ripple voltage; Z: Specific frequency impedance

**SMD CONDUCTIVE POLYMER TANT. CAP. CA55 SERIES CASE B**

(3) Ripple voltage

The ripple voltage applied to the capacitor is limited by three criteria.

- (a) The power dissipation in the ESR of capacitor must not exceed 75 mW Max. @+25°C
- (b) The positive peak AC voltage plus the DC bias voltage must not exceed the DC voltage rating of the capacitor.
- (c) The negative peak AC voltage, in combination with the bias voltage, if any , must not exceed the permissible reverse voltage ratings presented .

**2) Reverse voltage**

Solid tantalum capacitors are polarized devices , and applied reverse voltage can not be allowed . If the reverse voltage is unavoidable, a small degree of transient reverse voltage is permissible for short periods as follow.

25°C..... 10% of Max. rated voltage or 1V whichever is smaller

85°C..... 5% of Max. rated voltage or 0.5V whichever is smaller

125°C.....1% of Max. rated voltage or 0.1V whichever is smaller

Even under these restrictions, capacitors can not be used continuously in reverse voltage mode.

**3) Working voltage**

- (1) For general applications, using 50% of rated voltage of capacitors or less.
- (2) When used at the power circuit, low impedance circuit , coupling circuit or witching circuit which has leakage current problems, please design the circuit with voltage under 30% of the working voltage ( max 50%) to avoid the adverse effect of the surge current.
- (3) Derating voltage when temperature above 85°C.

When the chip tantalum capacitor is used at 85°C or more temperatures, the reduced voltage ( $U_T$ ) is calculated from the following expression, however, note that the ambient temperature is not more than 125°C.

$$U_T = V_0 (U_R - U_C)(T - 85) / 40$$

$U_R$ : Rated voltage (V);  $U_C$ : Derating voltage at 125°C; T: Ambient temperature (°C )

## SMD CONDUCTIVE POLYMER TANT. CAP. CA55 SERIES CASE B

### 4) Protective resistance

In a circuit (switching circuit, charge / discharge circuit, etc.) that has an instantaneous current, series resistance is at least  $3\Omega/V$ , this can improve the reliability of tantalum capacitors. If the capacitor is in a low impedance circuit, the voltage applied to the capacitor should be half or one third of the rated voltage.

### 5) Redundancy

MnO<sub>2</sub> tantalum capacitors will heat, and may cause fire and burn in the short circuit. This is determined by the situation, time and other factors. When the circuit is designed, it is possible to provide the best possible space to keep the tantalum capacitor reliability.

### 6) Test Condition

Ambient Temperature 25°C; Relative Humidity 60 to 70%; Air Pressure 800 to 1060mbar. Test and experiment, in order to make the test results not problems, it is necessary to will test the product after fully discharge.

This product is a polar components, testing or when using it is strictly prohibited to will is negative pick back, in order to avoid performance failure

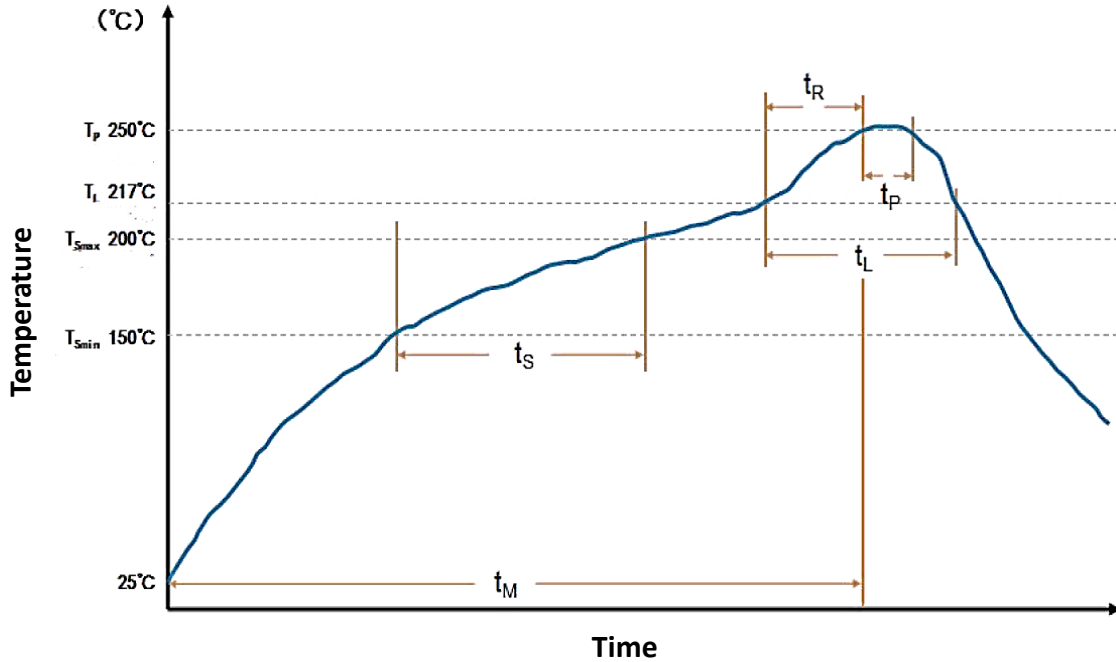
### 7) Soldering

The SMD tantalum capacitor can be used for reflow soldering, which is not suitable for wave soldering and manual welding. The reflow temperature are  $\leq 250^{\circ}\text{C}$ ,  $\leq 5$  seconds. If you must use manual welding, should use the melted solder to contact lead, and the electric soldering iron power should be less than or equal to 25W, temperature should be less than  $300^{\circ}\text{C}$ , welding time should be less than 3 seconds, can not use electric iron contact the product lead directly, and in particular, can not contact the product ontology directly. Recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020D standard for moisture sensitivity testing



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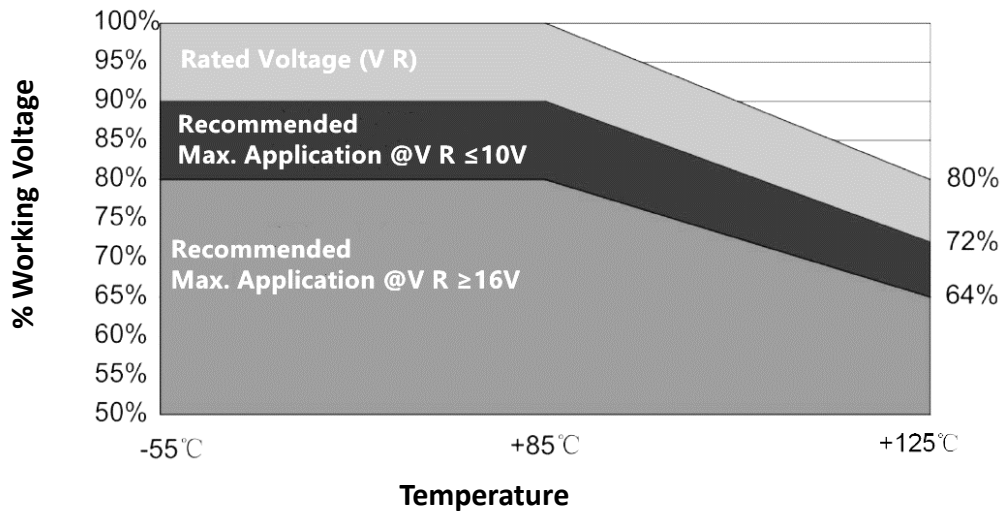
8) Recommended Profile Conditions



Characteristics	Unit	Symbol	SnPb Assembly	Pb-Free Assemble
Preheat Temperature Min.	°C	T smin	100	150
Preheat Temperature Max.	°C	T smax	150	200
Preheat time	Second	T s	60~120	60~120
Ramp-up Rate	°C/Second	T L to T p	≤ 3	≤ 3
Liquidous Temperature	°C	T L	183	217
Time Above Liquidous	Second	t L	30~150	60~150
Peak Temperature	°C	T p	220 or 235	245 or 250
Time within 5°C Max. Peak Temperature	Second	t p	≤ 10	≤ 3
Ramp-down Rate	°C/Second	T p to T L	≤ 6	≤ 6
Time 25°C to Peak Temperature	minute		≤ 6	≤ 6

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9) Recommended Voltage Derating Guidelines



Condition	-55 °C ~ 85 °C	-55 °C ~ 125 °C
% Change in Working DC Voltage with Temperature	V <sub>R</sub>	80% of V <sub>R</sub>
Recommended Max. Application @V <sub>R</sub> ≤10V	90 of V <sub>R</sub>	72% of V <sub>R</sub>
Recommended Max. Application @V <sub>R</sub> ≥16V	80% of V <sub>R</sub>	64% V <sub>R</sub>

**SMD CONDUCTIVE POLYMER TANT. CAP. CA55 SERIES CASE B**

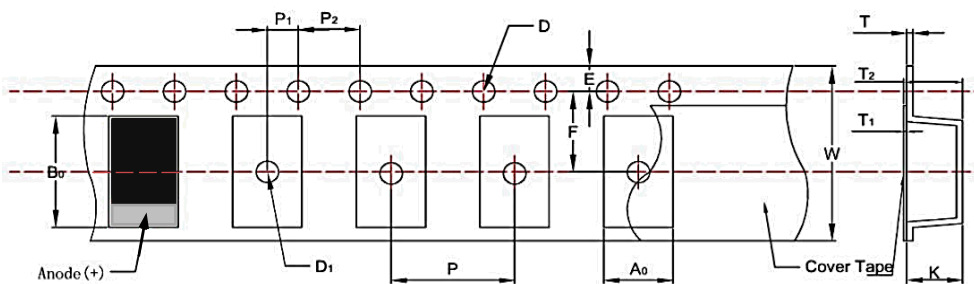
**REEL 7"/180MM DIMENSION (Unit: mm, 2000pcs/Reel)**



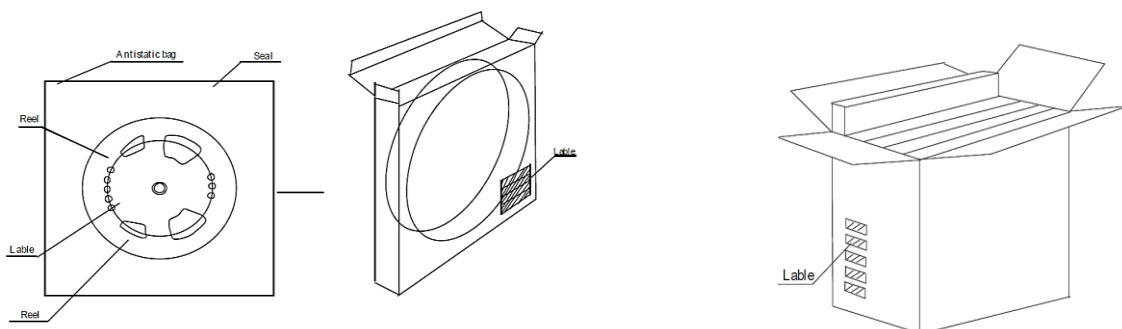
Code	Dimension
A	178.0+/-2.0
B	50.0 Min.
C	13.0+/-0.50
G	8.40+/-1.0
T	1.50+/-1.0

**TAPE WIDTH 8MM DIMENSION (Unit: mm)**

Note: Tolerance ±0.2mm over 10 sprocket hole spaces



Code	Dimension
A 0	3.15+/-0.10
B 0	3.77+/-0.10
K	2.22+/-0.10
W	8.00+/-0.30
E	1.75+/-0.10
F	3.50+/-0.05
P	4.00+/-0.10
P 1	2.00+/-0.05
P 2	4.00+/-0.10
D	1.50+/-0.20
D 1	1.00+/-0.25



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